Advanced Reflow Soldering Seminar Temperature Profiling and Troubleshooting





March 29, 2023 in Timisoara, Romania

Today reflow soldering is still the most important connection technology for electronic assemblies. Our Advanced Reflow Soldering Seminar in Timisoara will focus on several important factors that influence the reflow soldering quality: What are the main aspects of an optimal soldering profile? How can you avoid common and special defect mechanisms? At an open round table, you can discuss your problems concerning reflow soldering with experts in this field. Rehm Thermal Systems invites you to broaden your horizon at this opportunity and welcomes you to Timisoara.

March 29, 2023

09.30 a.m.	Welcome and Introduction Andreas Heltmann, Rehm Thermal Systems	1.15 p.m.	Innovations of Rehm Thermal Systems Andreas Heltmann, Rehm Thermal Systems	
09.45 a.m.	Basics of Reflow Profiling Dr. Paul Wild, Rehm Thermal Systems	1.45 p.m.	Interaction of solder paste formulation and soldering defects	
10.15 a.m.	Measuring Board Preparation + Tips & Tricks		N.N.	
	Dr. Paul Wild, Rehm Thermal Systems	3.00 p.m.	Round Table Discussion and Coffee Break	
11.15 a.m.	Coffee Break		All participants	
11.45 a.m.	Reflow Profiling Dr. Paul Wild. Rehm Thermal Systems	3.45 p.m.	Troubleshooting Dr. Paul Wild, Rehm Thermal Systems	
12.30 p.m.	,	5.00 p.m.	End of seminar Time for discussions and Get-Together	
	Reflow Profiling Dr. Paul Wild, Rehm Thermal Systems		Dr. Paul Wild, Rehm Thermal Systems	

Attendance fees including beverage, lunch and seminar material

129,00 € per day >> registration **before** February 23, 2023 149,00 € per day >> registration **after** February 23, 2023

Register for both days and get an extra discount of 10% on the above attendance fee!

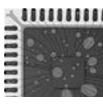
Subject to substantive adjustments













Advanced Conformal Coating Seminar Conformal Coating





March 30, 2023 in Timisoara, Romania

How do you ensure sustainable PCB protection for your electronic components? The coating technology in the electronics industry continues to advance. The wide range of materials and application methods are specially adapted to the assembly to be produced. It is not easy not to lose the overview here. On the second day of our seminar, you will learn about the basics and the diversity of coating technology and smart communication in line through to failure analysis of your coated product.

March 30, 2023

09.30 a.m.	Welcome and Introduction Gianfranco Sinistra, Rehm Thermal Systems	11.45 a.m.	Failure Analysis <i>Gianfranco Sinistra, Rehm Thermal Systems</i>
09.35 a.m.	Basics of Coating Materials Gianfranco Sinistra, Rehm Thermal Systems	12.45 p.m.	Lunch Break
10.30 a.m.	Coffee Break	1.45 p.m.	Cleaning: Pro and Cons - Necessity in different Environmental Conditions Gianfranco Sinistra, Rehm Thermal Systems
10.45 a.m.	Variety of Coating Technologies		
	- Different Applications Gianfranco Sinistra, Rehm Thermal Systems	2.30 p.m.	Line Connectivity - Smart Communications Gianfranco Sinistra, Rehm Thermal Systems
11.15 p.m.	Coffee Break	3.30 p.m.	End of Seminar Time for Discussions and Get-Together

Attendance fees including beverage, lunch and seminar material

129,00 € per day >> registration **before** February 23, 2023 149,00 € per day >> registration **after** February 23, 2023

Register for both days and get an extra discount of 10% on the above attendance fee!

Subject to substantive adjustments















Registration to the Advanced Reflow Soldering and Conformal Coating Seminar in Timisoara

EARLY BOOKING DISCOUNT

Your participation ☐ March 29, 2023 ☐ March 30, 2023

129,00 € per day

>> registration **before** February 23, 2023

149,00 € per day

>> registration **after** February 23, 2023

Register for both days and get an extra discount of 10% on the participation fee!

Subject to a minimum number of 20 participants

I will participate in the semi	nar with person(s) in total.
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- » Return to Ms. Ina Haug by E-Mail: i.haug@rehm-group.com
- » Or register on our Website: www.rehm-group.com/en/news/dates

Location of the seminar is **HOTEL TIMISOARA**, **300086 Marasesti Str. 1-3, Timisoara**, **Romania**. If you need an accommodation you can book a room from our contingent with the keyword.

Keyord: REHM TECHNOLOGY SEMINAR

Mrs. Teodora Munteanu | E-Mail: office@hoteltimisoara.ro Phone: +40 256 498852 | Web: www.hoteltimisoara.ro

The price for one single room is 70 € (Business room) per night incl. breakfast.

The contingent is available until March 5, 2023.















